

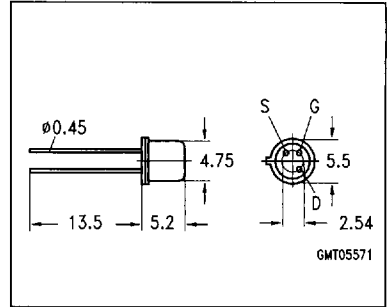
$$V_{DS} = 240 \text{ V}$$

$$I_D = 0.35 \text{ A}$$

$$R_{DS(on)} = 6.0 \Omega$$

- N channel
- Enhancement mode
- Package: TO-18¹⁾

Not for new design!



Type	Ordering code for version in bulk
■ BSS 91	Q 62702-S457

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	V_{DS}	240	V
Drain-gate voltage, $R_{GS} = 20 \text{ k}\Omega$	V_{DGR}	240	
Gate-source voltage	V_{GS}	± 14	
Gate-source peak voltage, aperiodic	V_{gs}	± 20	
Continuous drain current, $T_C = 25 \text{ }^\circ\text{C}$	I_D	0.35	A
Pulsed drain current, $T_C = 25 \text{ }^\circ\text{C}$	$I_{D \text{ puls}}$	1.4	
Max. power dissipation, $T_A = 25 \text{ }^\circ\text{C}$	P_{tot}	1.5	W
Operating and storage temperature range	T_J, T_{stg}	$-55 \dots +150$	$^\circ\text{C}$
Thermal resistance, chip-ambient (without heat sink), chip-case	R_{thJA}	≤ 300	K/W
	R_{thJC}	≤ 83	
DIN humidity category, DIN 40 040	—	E	—
IEC climatic category, DIN IEC 68-1	—	55/150/56	

¹⁾ See chapter Package Outlines.

Electrical Characteristics

at $T_j = 25\text{ °C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain-source breakdown voltage $V_{GS} = 0, I_D = 0.25\text{ mA}$	$V_{(BR)DSS}$	240	–	–	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = 1\text{ mA}$	$V_{GS(th)}$	0.8	1.5	2.0	
Zero gate voltage drain current $V_{DS} = 240\text{ V}, V_{GS} = 0$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$	I_{DSS}	–	0.1	1.0	μA
		–	10	100	
$V_{DS} = 60\text{ V}, V_{GS} = 0$ $T_j = 25\text{ °C}$		–	–	200	nA
Gate-source leakage current $V_{GS} = 20\text{ V}, V_{DS} = 0$	I_{GSS}	–	10	100	nA
Drain-source on-resistance $V_{GS} = 10\text{ V}, I_D = 0.35\text{ A}$ $V_{GS} = 4.5\text{ V}, I_D = 0.35\text{ A}$	$R_{DS(on)}$	–	3.5	6.0	Ω
		–	5.0	10.0	

Dynamic Characteristics

Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}, I_D = 0.35\text{ A}$	g_{fs}	0.14	0.37	–	S
Input capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	C_{iss}	–	115	155	pF
Output capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	C_{oss}	–	15	25	
Reverse transfer capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	C_{rss}	–	8	12	
Turn-on time t_{on} , ($t_{on} = t_{d(on)} + t_r$) $V_{DD} = 30\text{ V}, V_{GS} = 10\text{ V}, R_{GS} = 50\ \Omega, I_D = 0.28\text{ A}$	$t_{d(on)}$	–	6	9	ns
	t_r	–	10	15	
Turn-off time t_{off} , ($t_{off} = t_{d(off)} + t_f$) $V_{DD} = 30\text{ V}, V_{GS} = 10\text{ V}, R_{GS} = 50\ \Omega, I_D = 0.28\text{ A}$	$t_{d(off)}$	–	33	45	
	t_f	–	22	30	

Electrical Characteristics (cont'd)

at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

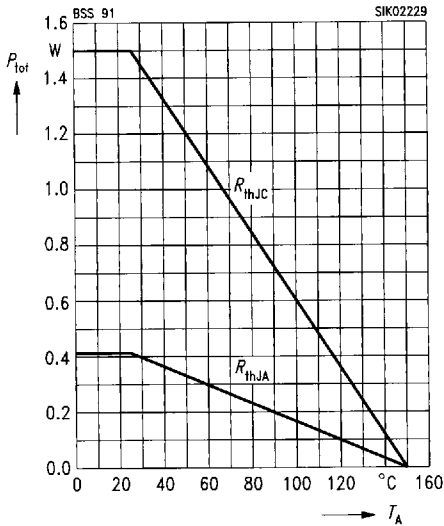
Reverse Diode

Continuous reverse drain current $T_A = 25\text{ }^\circ\text{C}$	I_S	—	—	0.35	A
Pulsed reverse drain current $T_A = 25\text{ }^\circ\text{C}$	I_{SM}	—	—	1.4	
Diode forward on-voltage $I_F = 0.7\text{ A}$, $V_{GS} = 0$	V_{SD}	—	0.9	1.4	V

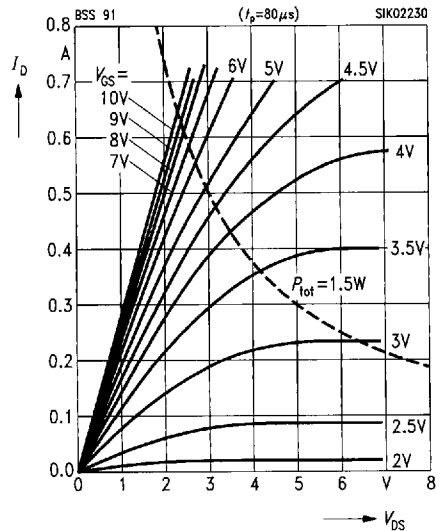
Characteristics

at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified.

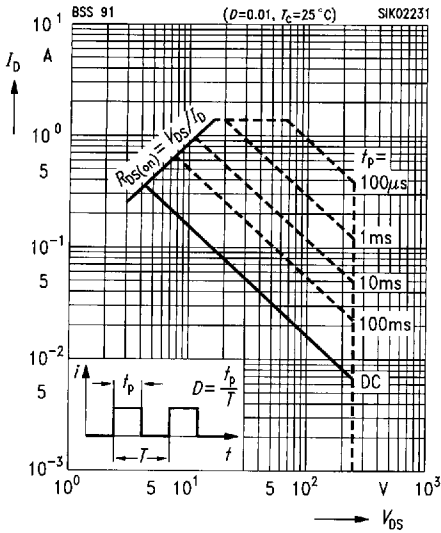
Total power dissipation $P_{tot} = f(T_A)$



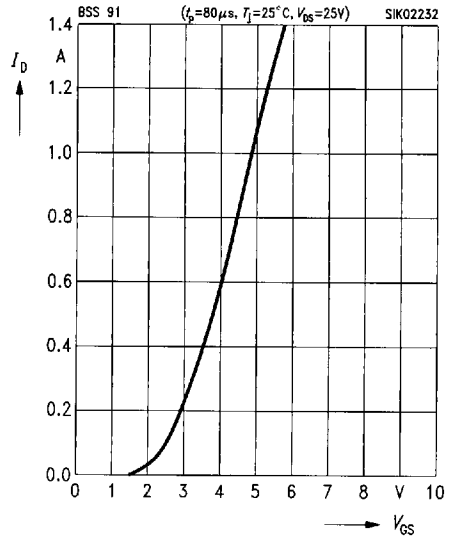
Typ. output characteristics $I_D = f(V_{DS})$
parameter: $t_p = 80\text{ }\mu\text{s}$



Safe operating area $I_D = f(V_{DS})$
 parameter: $D = 0.01, T_C = 25^\circ\text{C}$

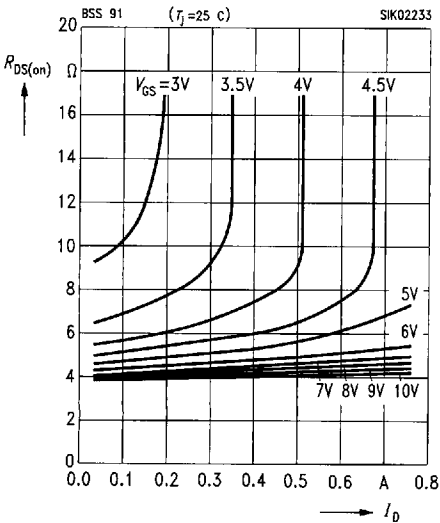


Typ. transfer characteristics $I_D = f(V_{GS})$
 parameter: $t_p = 80 \mu\text{s}, V_{DS} = 25 \text{ V}$



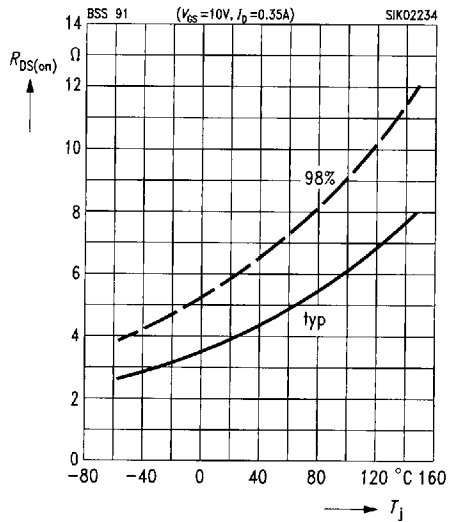
Typ. drain-source on-resistance

$R_{DS(on)} = f(I_D)$
 parameter: V_{GS}

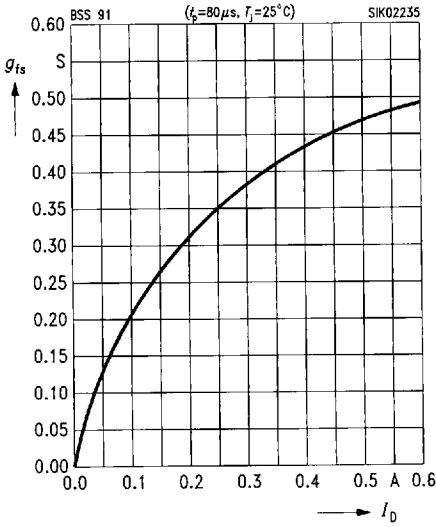


Drain-source on-resistance

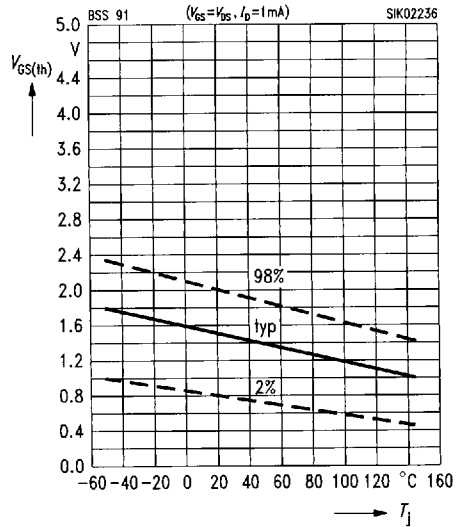
$R_{DS(on)} = f(T_j)$
 parameter: $I_D = 0.35 \text{ A}, V_{GS} = 10 \text{ V}, (\text{spread})$



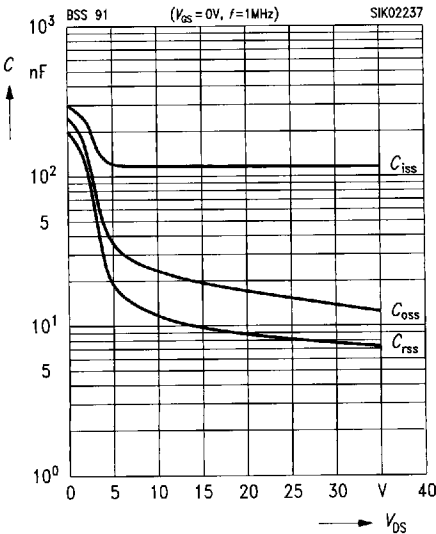
Typ. forward transconductance $g_{fs} = f(I_D)$
 parameter: $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$, $t_p = 80 \mu s$



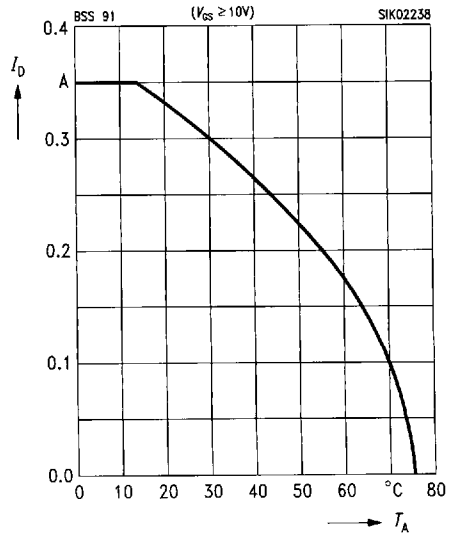
Gate threshold voltage $V_{GS(th)} = f(T_j)$
 parameter: $V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$, (spread)



Typ. capacitances $C = f(V_{DS})$
 parameter: $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$



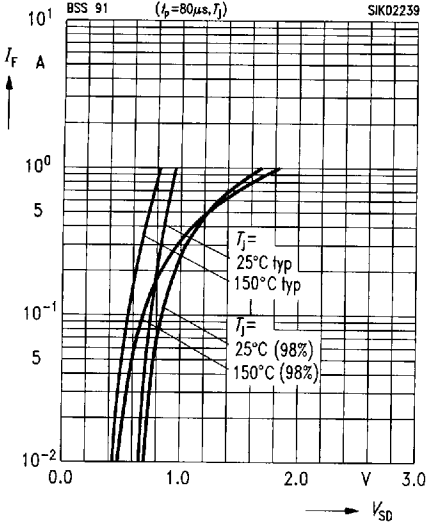
Drain current $I_D = f(T_A)$
 parameter: $V_{GS} \geq 10 \text{ V}$



Forward characteristics of reverse diode

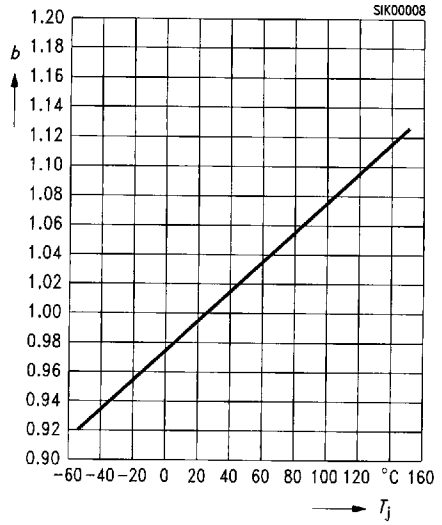
$I_F = f(V_{SD})$

parameter: $t_p = 80 \mu s, T_j, (\text{spread})$



Drain-source breakdown voltage

$V_{(BR)DSS} = b \times V_{(BR)DSS}(25^\circ\text{C})$



This datasheet has been downloaded from:

www.DatasheetCatalog.com

Datasheets for electronic components.



LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

LittleDiode.com

Looking forward to providing you with the best possible service.